

SAW Rx filter
Automotive telematics
TD-LTE band 38

Series/type: B4342

Ordering code: B39262B4342P810

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SAW Rx filter 2595 MHz

Data sheet

Table of contents

1 Application	3
2 <u>Features</u>	
3 <u>Package</u>	
4 Pin configuration	
5 Matching circuit	
6 Characteristics	
7 Maximum ratings	7
3 Transmission coefficient	8
Reflection coefficients.	9
10 Common-mode rejection ratio	10
11 Packing material.	11
12 Marking	
13 Soldering profile	
14 ESD protection of SAW filters	15
15 Annotations	
16 <u>Cautions and warnings</u>	17
Important notes.	



SAW Rx filter 2595 MHz

Data sheet

1 Application

- Low-loss RF filter for TD-LTE Band 38 system
- Usable band width 50 MHz
- Low amplitude ripple
- Unbalanced to balanced operation

2 Features

- Package size 1.4±0.1 mm × 1.1±0.1 mm
- Package height 0.45 mm (max.)
- Package code QCS5P
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- AEC-Q200 qualified component family (operable temperature range -40 °C to +85 °C)
- Electrostatic Sensitive Device (ESD)



Figure 1: Picture of component with example of product marking.

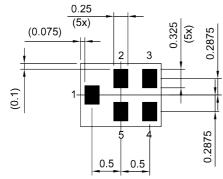


SAW Rx filter 2595 MHz

Data sheet

3 Package

BOTTOM VIEW



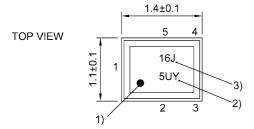
Pad and pitch tolerance ±0.05

4 Pin configuration

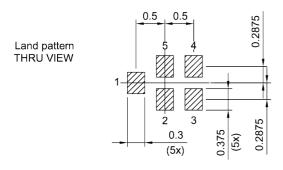
- 1 Input
- 3, 4 Output balanced
- 2, 5 Ground

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Simplified drawings (p. 17).



SAW components

B4342

SAW Rx filter

2595 MHz

Data sheet

5 Matching circuit

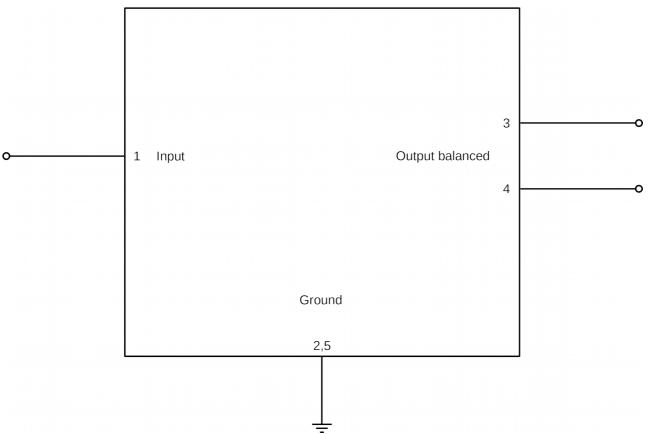


Figure 3: Schematic of matching circuit. No external matching components required.



SAW Rx filter 2595 MHz

Data sheet

Characteristics

 $T_{ ext{SPEC}} \ Z_{ ext{IN}} \ Z_{ ext{OUT}}$ Temperature range for specification = -30 °C ... +85 °C = 50 Ω Input terminating impedance

Output terminating impedance = 100 Ω

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	2595	_	MHz
Maximum insertion attenuation			α_{max}				
	2570 2620	MHz		_	2.1	2.5	dB
Amplitude ripple (p-p)			Δα				
	2570 2620	MHz		_	0.6	1.2	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	2570 2620	MHz		_	1.6	2.1	
@ output port	2570 2620	MHz		_	1.7	2.2	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	50 2400	MHz		43	47	_	dB
	2400 2485	MHz		29	32	_	dB
	2485 2510	MHz		20	37	_	dB
	2510 2555	MHz		1.3	2	_	dB
	2635 2680	MHz		1.3	2	_	dB
	2680 2705	MHz		20	35	_	dB
	2705 6000	MHz		30	35	_	dB
Minimum common-mode rejection ratio			$CMRR_{_{min}}$				
	2570 2620	MHz		17	24	_	dB



SAW components

B4342

SAW Rx filter

2595 MHz

Data sheet

7 Maximum ratings

Operable temperature	T _{OP} = -40 °C +85 °C	
Storage temperature	T _{STG} = -40 °C +85 °C	
DC voltage	V _{DC} = 0 V	
Input power @ input port	P _{IN} = 10 dBm	Continuous wave for 10000 h @ 55 °C.



SAW Rx filter 2595 MHz

Data sheet

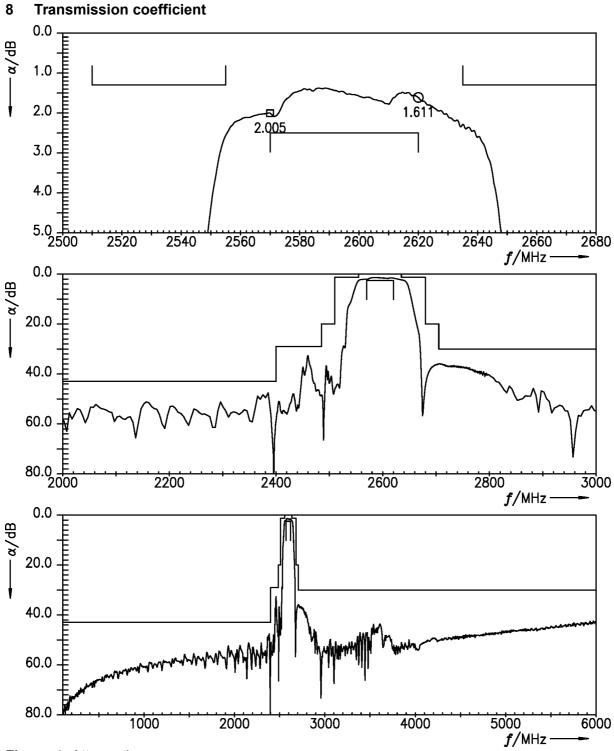


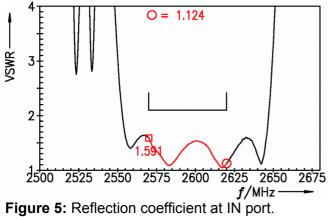
Figure 4: Attenuation.

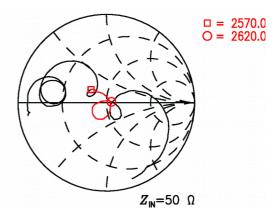


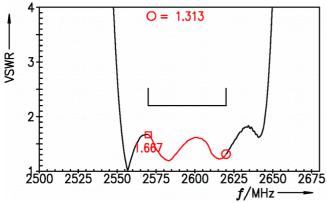
SAW Rx filter 2595 MHz

Data sheet

Reflection coefficients 9







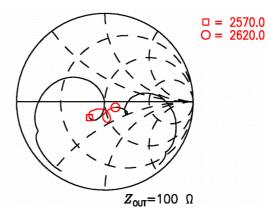


Figure 6: Reflection coefficient at OUT port.



SAW Rx filter 2595 MHz

Data sheet

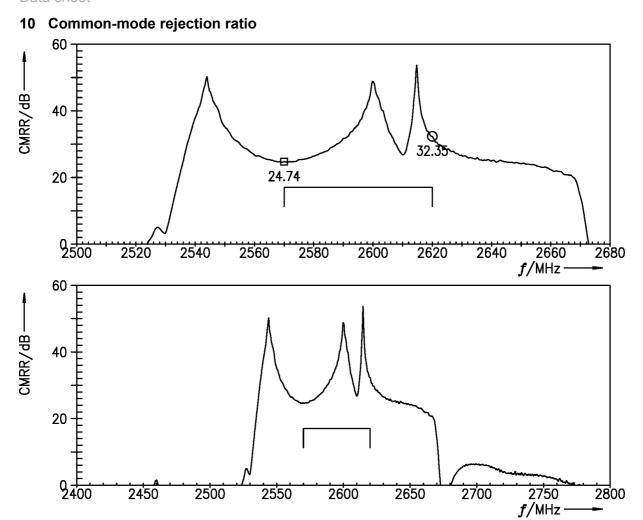


Figure 7: Common-mode rejection ratio.

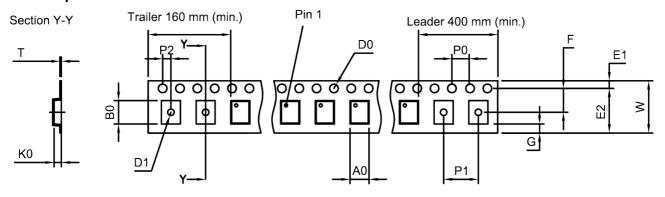


SAW Rx filter 2595 MHz

Data sheet

11 Packing material

11.1 Tape



User direction of unreeling

Figure 8: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	1.27±0.05 mm	E ₂	6.25 mm (min.)	P ₁	4.0 _{±0.1} mm
B ₀	1.57±0.05 mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D ₁	0.5 _{±0.1} mm	K	0.62±0.05 mm	W	8.0+0.3/-0.1 mm
E₁	1.75±0.1 mm	Po	4.0 _{±0.1} mm		

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

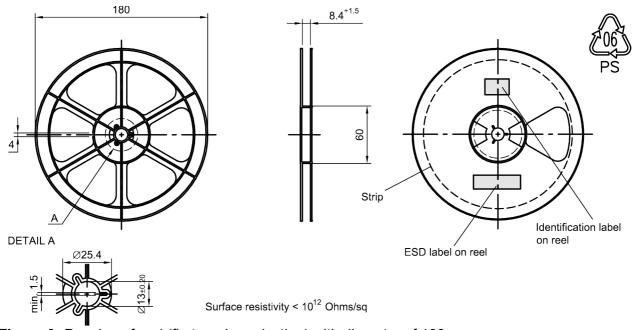


Figure 9: Drawing of reel (first-angle projection) with diameter of 180 mm.



SAW Rx filter 2595 MHz

Data sheet

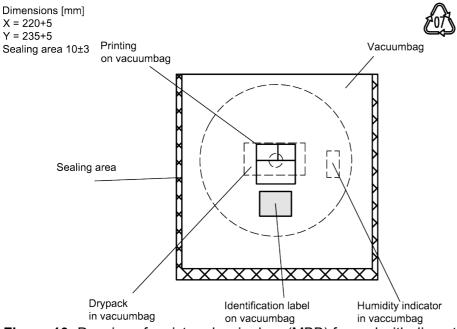


Figure 10: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

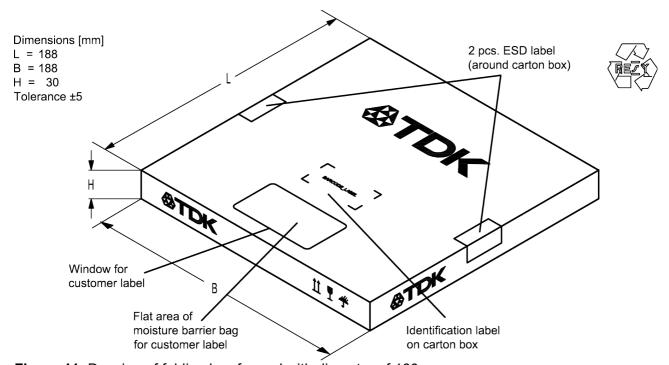


Figure 11: Drawing of folding box for reel with diameter of 180 mm.



SAW Rx filter 2595 MHz

Data sheet

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B4342 is 47P.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 5 x 47² + 27 (=U) x 47¹ + 31 (=Y) x 47⁰ = 12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	Α	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	Α	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	V
17	Н	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	Р		

Table 2: Lists for encoding and decoding of marking.



SAW components

B4342

SAW Rx filter

2595 MHz

Data sheet

13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T _{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

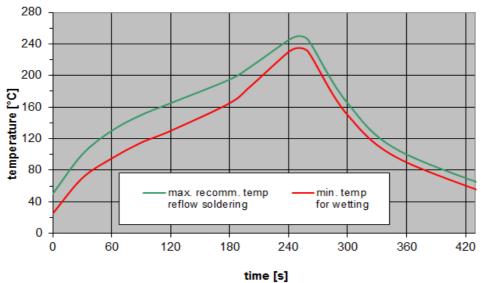


Figure 12: Recommended reflow profile for convection and infrared soldering – lead-free solder.



SAW Rx filter 2595 MHz

Data sheet

14 ESD protection of SAW filters

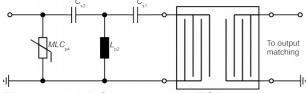
SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.



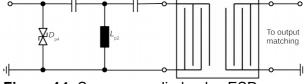


Figure 13: MLC varistor plus ESD matching.

Figure 14: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

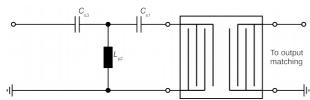


Figure 15: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor $L_{\rm p2}$ could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to EPCOS Application report: "**ESD protection for SAW filters**". This report can be found under www.epcos.com/rke. Click on "Applications Notes".



SAW Rx filter 2595 MHz

Data sheet

15 Annotations

15.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

15.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

15.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.



SAW Rx filter 2595 MHz

Data sheet

16 Cautions and warnings

16.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

16.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

16.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

16.4 Simplified drawings

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



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- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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